

November 2013

FQL40N50

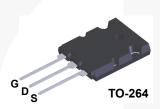
N-Channel QFET® MOSFET 500 V, 40 A, 110 mΩ

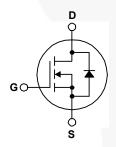
Description

This N-Channel enhancement mode power MOSFET is • 40 A, 500 V, $R_{DS(on)}$ = 110 m Ω (Max.) @ V_{GS} = 10 V, produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state • Low Gate Charge (Typ. 155 nC) resistance, and to provide superior switching performance • Low Crss (Typ. 95 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

Features

- $I_D = 20 A$





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

| Symbol | Parameter | | FQL40N50 | Unit | |
|-----------------------------------|---|---------|-------------|------|--|
| V _{DSS} | Drain-Source Voltage | | 500 | V | |
| I _D | Drain Current - Continuous (T _C = 25°C) | | 40 | А | |
| | - Continuous (T _C = 100°C) | | 25 | А | |
| I _{DM} | Drain Current - Pulsed (| Note 1) | 160 | Α | |
| V _{GSS} | Gate-Source Voltage | | ± 30 | V | |
| E _{AS} | Single Pulsed Avalanche Energy (| Note 2) | 1780 | mJ | |
| I _{AR} | Avalanche Current (| Note 1) | 40 | A | |
| E _{AR} | Repetitive Avalanche Energy | Note 1) | 46 | mJ | |
| dv/dt | Peak Diode Recovery dv/dt (Note 3 | | lote 3) 4.5 | | |
| P_{D} | Power Dissipation (T _C = 25°C) | | 460 | W | |
| | - Derate above 25°C | | 3.7 | W/°C | |
| T _J , T _{STG} | Operating and Storage Temperature Range | | -55 to +150 | °C | |
| TL | Maximum lead temperature for soldering, 1/8" from case for 5 seconds. | | 300 | °C | |

Thermal Characteristics

| Symbol | Parameter | FQL40N50 | Unit | |
|-----------------|---|----------|------|--|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case, Max. | 0.27 | °C/W | |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient, Max. | 30 | °C/W | |

Package Marking and Ordering Information

| Part Number | Top Mark | Package | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|----------|---------|----------------|-----------|------------|----------|
| FQL40N50 | FQL40N50 | TO-264 | Tube | N/A | N/A | 25 units |

Electrical Characteristics

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|---|---|---|------|-------|------|------|
| Off Cha | racteristics | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 500 | | | V |
| ΔBV _{DSS} / ΔΤ _J | Breakdown Voltage Temperature Coefficient | I _D = 250 μA, Referenced to 25°C | | 0.48 | | V/°C |
| I _{DSS} | 7 0 . 1/4 5 . 0 | V _{DS} = 500 V, V _{GS} = 0 V | | | 1 | μΑ |
| | Zero Gate Voltage Drain Current | V _{DS} = 400 V, T _C = 125°C | | | 10 | μΑ |
| I _{GSSF} | Gate-Body Leakage Current, Forward | V _{GS} = 30 V, V _{DS} = 0 V | | | 100 | nA |
| I _{GSSR} | Gate-Body Leakage Current, Reverse | V _{GS} = -30 V, V _{DS} = 0 V | | | -100 | nA |
| On Cha | racteristics | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$ | 3.0 | | 5.0 | V |
| R _{DS(on)} | Static Drain-Source On-Resistance | V _{GS} = 10 V, I _D = 20 A | | 0.085 | 0.11 | Ω |
| 9 _{FS} | Forward Transconductance | V _{DS} = 50 V, I _D = 20 A | | 29 | | S |
| Dynami | ic Characteristics | | | | | |
| C _{iss} | Input Capacitance | $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ | | 5800 | 7500 | pF |
| C _{oss} | Output Capacitance | f = 1.0 MHz | | 880 | 1150 | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 95 | 120 | pF |
| Switchi | ng Characteristics | | | | | |
| t _{d(on)} | Turn-On Delay Time | V _{DD} = 250 V, I _D = 40 A, | | 140 | 290 | ns |
| t _r | Turn-On Rise Time | $R_{G} = 25 \Omega$ | | 440 | 890 | ns |
| t _{d(off)} | Turn-Off Delay Time | - 1.G - 20 22 | | 350 | 700 | ns |
| t _f | Turn-Off Fall Time | (Note 4) | | 250 | 500 | ns |
| Q _g | Total Gate Charge | V _{DS} = 400 V, I _D = 40 A, | | 155 | 200 | nC |
| Q _{gs} | Gate-Source Charge | V _{GS} = 10 V | | 37 | | nC |
| Q _{gd} | Gate-Drain Charge | (Note 4) | / | 78 | | nC |
| Drain-S | ource Diode Characteristics a | nd Maximum Ratings | | | | |
| Is | Maximum Continuous Drain-Source Diode Forward Current | | | | 40 | Α |
| I _{SM} | Maximum Pulsed Drain-Source Diode Forward Current | | | | 160 | Α |
| V _{SD} | Drain-Source Diode Forward Voltage | V _{GS} = 0 V, I _S = 40 A | | | 1.4 | V |
| t _{rr} | Reverse Recovery Time | V _{GS} = 0 V, I _S = 40 A, | | 520 | | ns |
| Q _{rr} | Reverse Recovery Charge dl _F / dt = 100 A/μs | | | 8.0 | // | μС |

- 1. Repetitive rating : pulse-width limited by maximum junction temperature.
- 2. L = 2.0 mH, I_{AS} = 40 A, V_{DD} = 50 V, R_G = 25 Ω , starting T_J = 25°C. 3. I_{SD} \leq 40 A, di/dt \leq 200 A/ μ s , V_{DD} \leq BV_{DSS}, starting T_J = 25°C. 4. Essentially independent of operating temperature.

Typical Characteristics

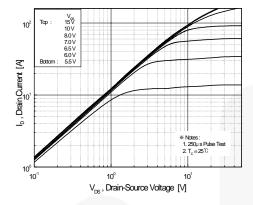


Figure 1. On-Region Characteristics

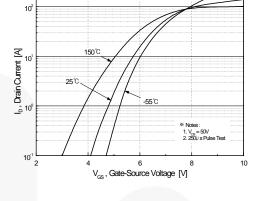


Figure 2. Transfer Characteristics

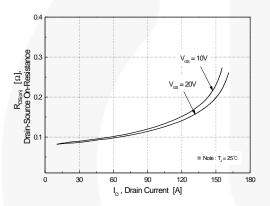


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

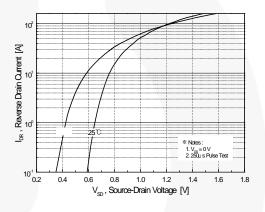


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

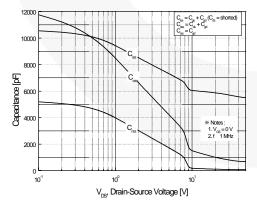


Figure 5. Capacitance Characteristics

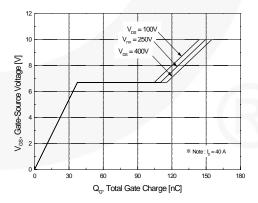


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

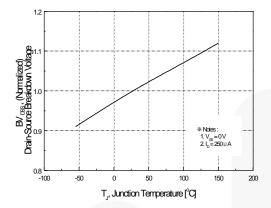


Figure 7. Breakdown Voltage Variation vs. Temperature

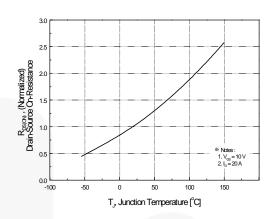


Figure 8. On-Resistance Variation vs. Temperature

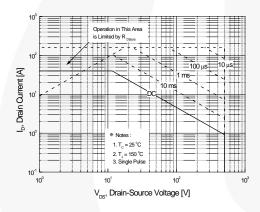


Figure 9. Maximum Safe Operating Area

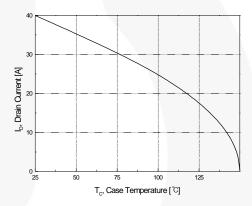


Figure 10. Maximum Drain Current vs. Case Temperature

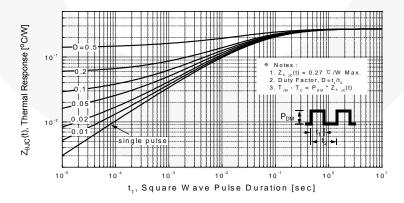


Figure 11. Transient Thermal Response Curve

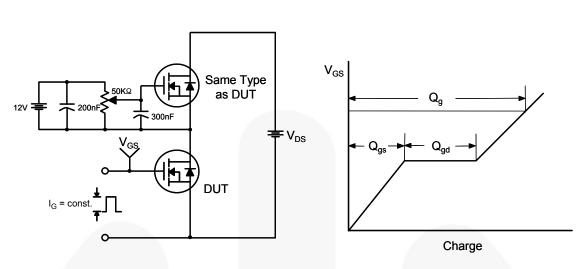


Figure 12. Gate Charge Test Circuit & Waveform

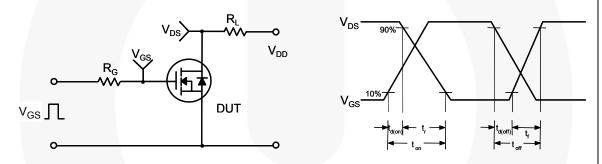


Figure 13. Resistive Switching Test Circuit & Waveforms

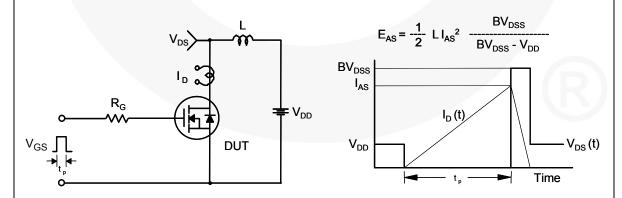
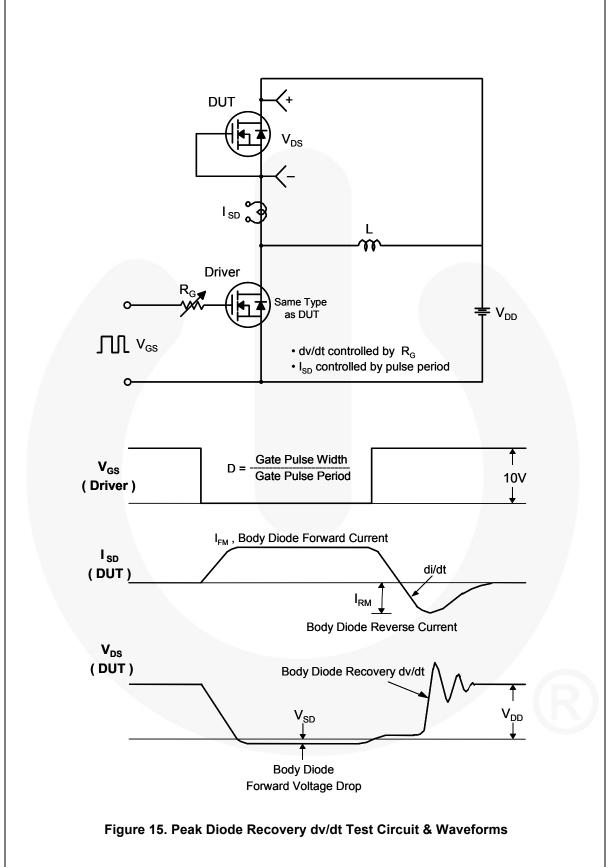
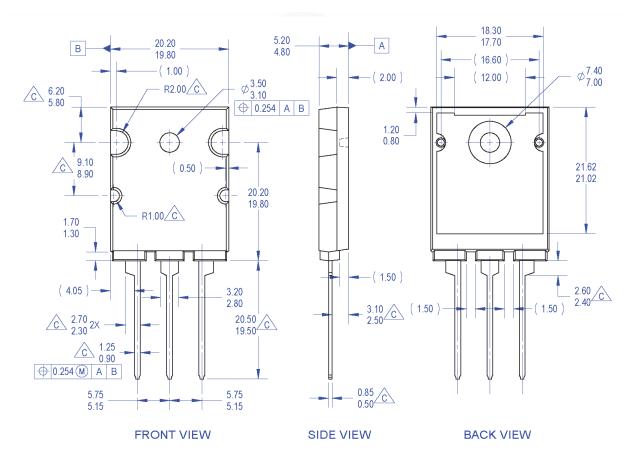
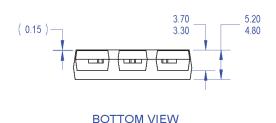


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



Mechanical Dimensions





NOTES:

- A. PACKAGE REFERENCE: JEDEC TO264 VARIATION AA
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- OUT OF JEDEC STANDARD VALUE.
 DIMENSION AND TOLERANCE AS PER ASME
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- E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS. F. THIS PACKAGE IS INTENDED ONLY FOR "FS PKG CODE AR"
- G. DRAWING FILE NAME: TO264A03REV1

Figure 16. TO264, Molded, 3-Lead, Jedec Variation AA

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